

1 inch
1 cm
1 mm

Fabrication Notes

Stackup

Designed for CircuitHub std 4-Layer 1.6mm stackup:

	Er	H(mm)	[mil]	Wg(oz)
1 Top Copper	Sig(GND)	0.035	[1.4]	1
7630	Prepreg	4.7	0.2	[7.9]
2 In1 Copper	Plane(GND)	0.035	[1.4]	1
[Fr-4?]	Core	4.6	1.03	[40.6]
3 In2 Copper	Plane(PWR)	0.035	[1.4]	1
7630	Prepreg	4.7	0.2	[7.9]
4 Bot Copper	Sig(GND)	0.035	[1.4]	1

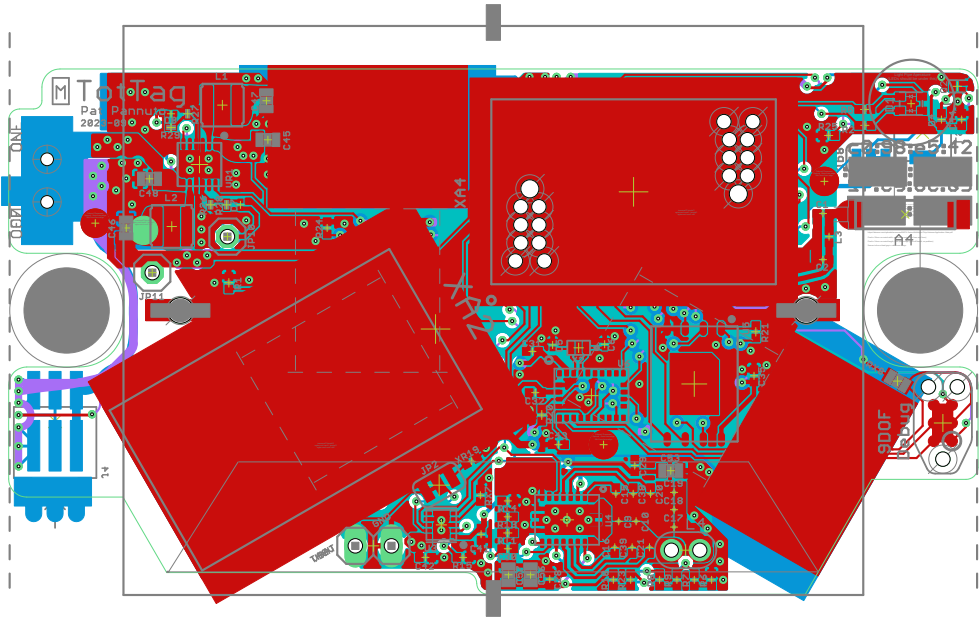
Impedance Control

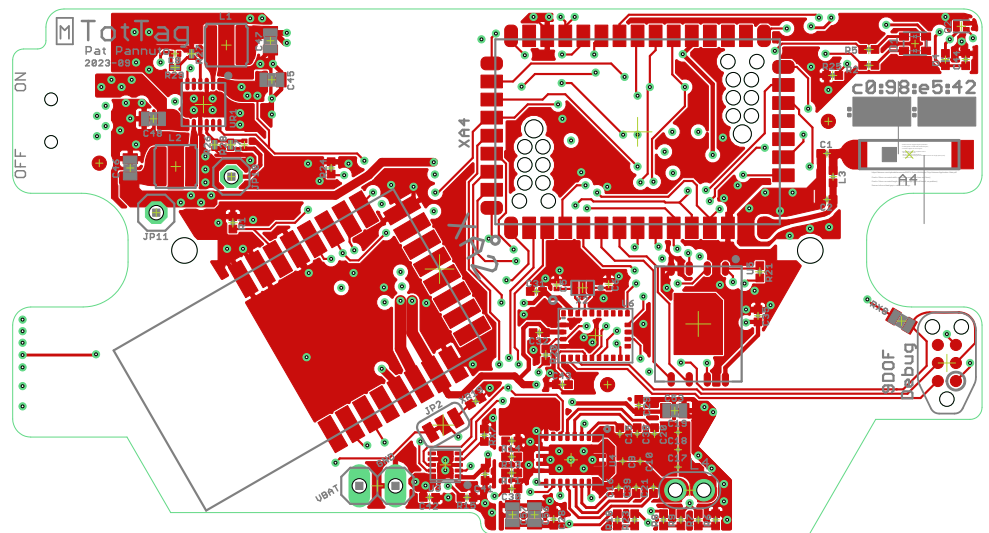
50Ω for Bluetooth RF [2.4 GHz]
- Controlled traces run from XA1-A4

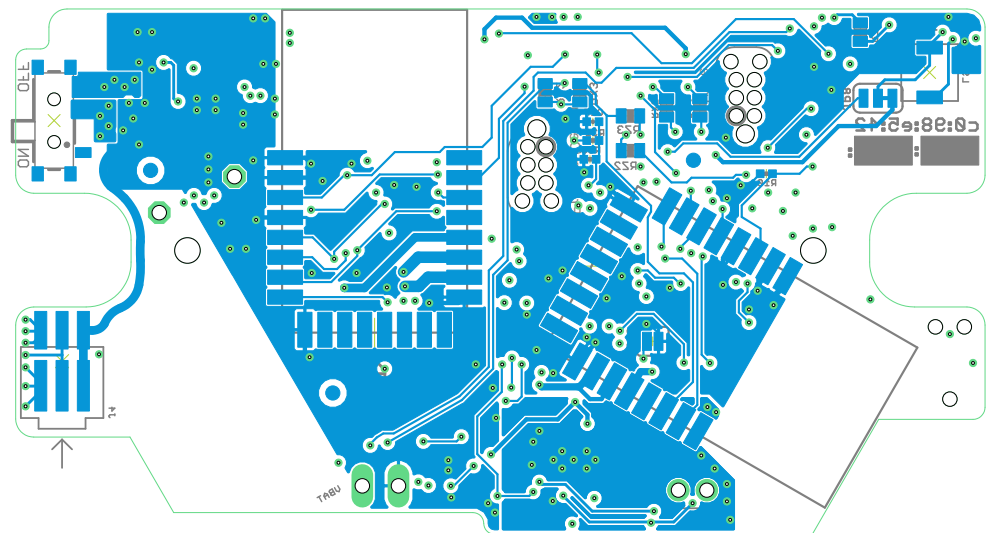
All modeled as Coplanar waveguide.
SaturnPCB Calculator Configuration:
W=14 mil (0.356 mm)
H= 7.87mil
G=10 mil
[W/H=1.779 < 2, √]
Er 4.7 is high end for 7630 materials
4.7 -> 49.9 Ω
4.6 -> 50.4 Ω
reasonable hedge

Panelization

Any OK.
OK to leave mouse bite tabs any edge.







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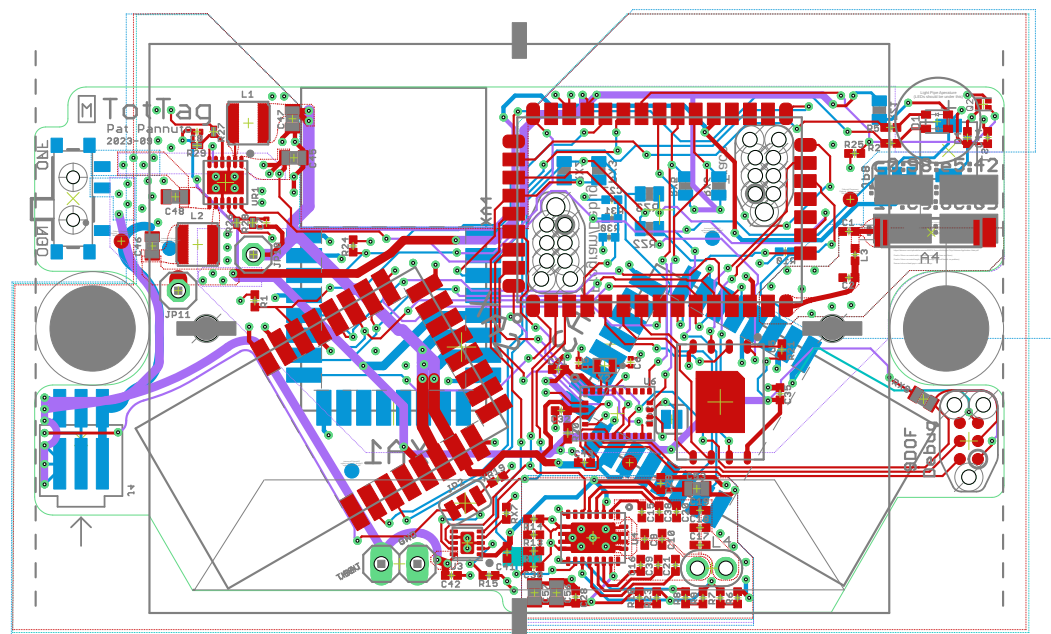
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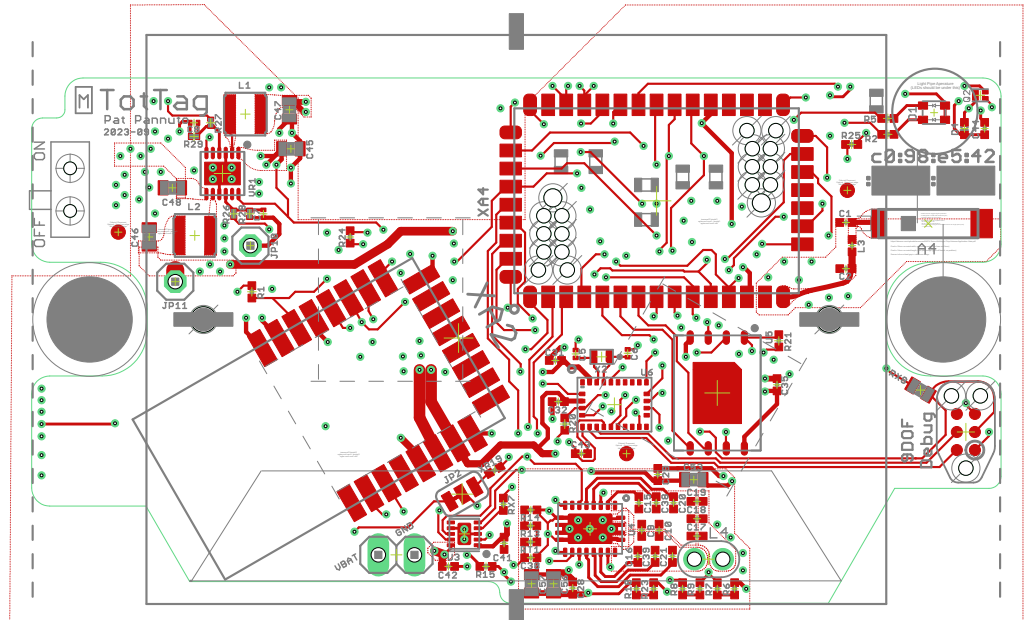
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